

# HiPerFET™ Power MOSFETs

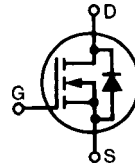
~~IXFH/IXFM 67 N10~~  
~~IXFH/IXFM 75 N10~~

| V <sub>DSS</sub> | I <sub>D25</sub> | R <sub>DS(on)</sub> |
|------------------|------------------|---------------------|
| 100 V            | 67 A             | 25 mΩ               |
| 100 V            | 75 A             | 20 mΩ               |

t<sub>rr</sub> ≤ 200 ns

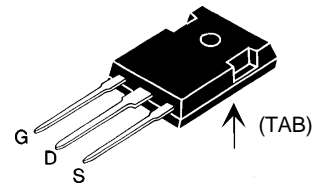
N-Channel Enhancement Mode  
High dv/dt, Low t<sub>rr</sub>, HDMOS™ Family

Obsolete:  
IXFM67N10  
IXFM75N10



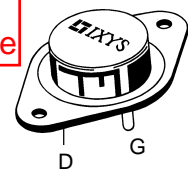
| Symbol           | Test Conditions   | Maximum Ratings             |           |
|------------------|---|-----------------------------|-----------|
| V <sub>DSS</sub> | T <sub>J</sub> = 25°C to 150°C  | 100                         | V         |
| V <sub>DGR</sub> | T <sub>J</sub> = 25°C to 150°C; R <sub>GS</sub> = 1 MΩ  | 100                         | V         |
| V <sub>GS</sub>  | Continuous  | ±20                         | V         |
| V <sub>GSM</sub> | Transient   | ±30                         | V         |
| I <sub>D25</sub> | T <sub>C</sub> = 25°C   | 67N10                       | 67 A      |
|                  |   | 75N10                       | 75 A      |
| I <sub>DM</sub>  | T <sub>C</sub> = 25°C, pulse width limited by T <sub>JM</sub>   | 67N10                       | 268 A     |
|                  |   | 75N10                       | 300 A     |
| I <sub>AR</sub>  | T <sub>C</sub> = 25°C   | 67N10                       | 67 A      |
|                  |   | 75N10                       | 75 A      |
| E <sub>AR</sub>  | T <sub>C</sub> = 25°C   | 30                          | mJ        |
| dv/dt            | I <sub>S</sub> ≤ I <sub>DM</sub> , di/dt ≤ 100 A/μs, V <sub>DD</sub> ≤ V <sub>DSS</sub> ,<br>T <sub>J</sub> ≤ 150°C, R <sub>G</sub> = 2 Ω | 5                           | V/ns      |
| P <sub>D</sub>   | T <sub>C</sub> = 25°C   | 300                         | W         |
| T <sub>J</sub>   |   | -55 ... +150                | °C        |
| T <sub>JM</sub>  |   | 150                         | °C        |
| T <sub>stg</sub> |   | -55 ... +150                | °C        |
| T <sub>L</sub>   | 1.6 mm (0.062 in.) from case for 10 s   | 300                         | °C        |
| M <sub>d</sub>   | Mounting torque   | 1.13/10                     | Nm/lb.in. |
| Weight           |   | TO-204 = 18 g, TO-247 = 6 g |           |

TO-247 AD (IXFH)



~~TO-204 AE (IXFM)~~

Package  
unavailable



G = Gate, D = Drain,  
S = Source, TAB = Drain

### Features

- International standard packages
- Low R<sub>DS(on)</sub> HDMOS™ process
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect
- Fast intrinsic Rectifier

### Applications

- DC-DC converters
- Synchronous rectification
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor control
- Temperature and lighting controls
- Low voltage relays

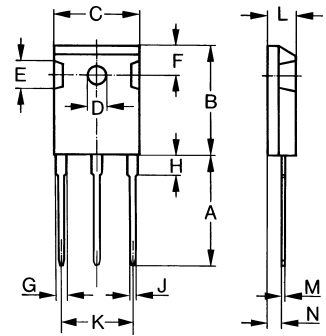
### Advantages

- Easy to mount with 1 screw (TO-247) (isolated mounting screw hole)
- Space savings
- High power density

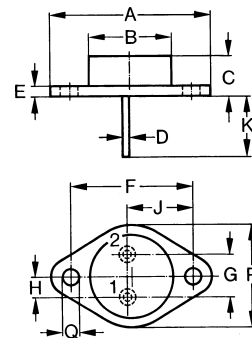
| Symbol              | Test Conditions   | Characteristic Values<br>(T <sub>J</sub> = 25°C, unless otherwise specified) |      |         |
|---------------------|---|--|------|---------|
|                     |   | min.   | typ. | max.    |
| V <sub>DSS</sub>    | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA  | 100  |      | V       |
| V <sub>GS(th)</sub> | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 4 mA   | 2.0  |      | V       |
| I <sub>GSS</sub>    | V <sub>GS</sub> = ±20 V <sub>DC</sub> , V <sub>DS</sub> = 0   |  |      | ±100 nA |
| I <sub>DSS</sub>    | V <sub>DS</sub> = 0.8 • V <sub>DSS</sub><br>V <sub>GS</sub> = 0 V   | T <sub>J</sub> = 25°C  |      | 250 μA  |
|                     |   | T <sub>J</sub> = 125°C   |      | 1 mA    |
| R <sub>DS(on)</sub> | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 I <sub>D25</sub><br>Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 % | 67N10  |      | 0.025 Ω |
|                     |   | 75N10  |      | 0.020 Ω |

| Symbol       | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |      |    |
|--------------|---|---|------|------|----|
|              |   | min.  | typ. | max. |    |
| $g_{fs}$     | $V_{DS} = 10\text{ V}; I_D = I_{D25}$ , pulse test  | 25  | 30   | S    |    |
| $C_{iss}$    | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$   |   | 4500 | pF   |    |
| $C_{oss}$    |   |   | 1600 | pF   |    |
| $C_{rss}$    |   |   | 800  | pF   |    |
| $t_{d(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 I_{D25}$<br>$R_G = 2\ \Omega$ , (External) |   | 20   | 30   | ns |
| $t_r$        |   |   | 60   | 110  | ns |
| $t_{d(off)}$ |   |   | 80   | 110  | ns |
| $t_f$        |   |   | 60   | 90   | ns |
| $Q_{g(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 I_{D25}$                                   |   | 180  | 260  | nC |
| $Q_{gs}$     |   |   | 36   | 70   | nC |
| $Q_{gd}$     |   |   | 85   | 160  | nC |
| $R_{thJC}$   |   |   | 0.42 | K/W  |    |
| $R_{thCK}$   |   | 0.25  |      | K/W  |    |

| Symbol   | Test Conditions  | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |                  |
|----------|--|---|------|------------------|
|          |  | min.  | typ. | max.             |
| $I_S$    | $V_{GS} = 0\text{ V}$  | 67N10<br>75N10  |      | 67 A<br>75 A     |
| $I_{SM}$ | Repetitive;<br>pulse width limited by $T_{JM}$   | 67N10<br>75N10  |      | 268 A<br>300 A   |
| $V_{SD}$ | $I_F = I_S, V_{GS} = 0\text{ V}$ ,<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$                                |   |      | 1.75 V           |
| $t_{rr}$ | $I_F = 25\text{ A}, -di/dt = 100\text{ A}/\mu\text{s}$ , $T_J = 25^\circ\text{C}$<br>$V_R = 25\text{ V}$ , $T_J = 125^\circ\text{C}$ |   |      | 200 ns<br>300 ns |

**TO-247 AD (IXFH) Outline**


| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 19.81      | 20.32 | 0.780  | 0.800 |
| B    | 20.80      | 21.46 | 0.819  | 0.845 |
| C    | 15.75      | 16.26 | 0.610  | 0.640 |
| D    | 3.55       | 3.65  | 0.140  | 0.144 |
| E    | 4.32       | 5.49  | 0.170  | 0.216 |
| F    | 5.4        | 6.2   | 0.212  | 0.244 |
| G    | 1.65       | 2.13  | 0.065  | 0.084 |
| H    | -          | 4.5   | -      | 0.177 |
| J    | 1.0        | 1.4   | 0.040  | 0.055 |
| K    | 10.8       | 11.0  | 0.426  | 0.433 |
| L    | 4.7        | 5.3   | 0.185  | 0.209 |
| M    | 0.4        | 0.8   | 0.016  | 0.031 |
| N    | 1.5        | 2.49  | 0.087  | 0.102 |

**TO-204 AE (IXFM) Outline**


| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 38.61      | 39.12 | 1.520  | 1.540 |
| B    | -          | 22.22 | -      | 0.875 |
| C    | 6.40       | 11.40 | 0.252  | 0.449 |
| D    | 1.45       | 1.60  | 0.057  | 0.063 |
| E    | 1.52       | 3.43  | 0.060  | 0.135 |
| F    | 30.15      | BSC   | 1.187  | BSC   |
| G    | 10.67      | 11.17 | 0.420  | 0.440 |
| H    | 5.21       | 5.71  | 0.205  | 0.225 |
| J    | 16.64      | 17.14 | 0.655  | 0.675 |
| K    | 11.18      | 12.19 | 0.440  | 0.480 |
| Q    | 3.84       | 4.19  | 0.151  | 0.165 |
| R    | 25.16      | 26.66 | 0.991  | 1.050 |

Fig. 1 Output Characteristics

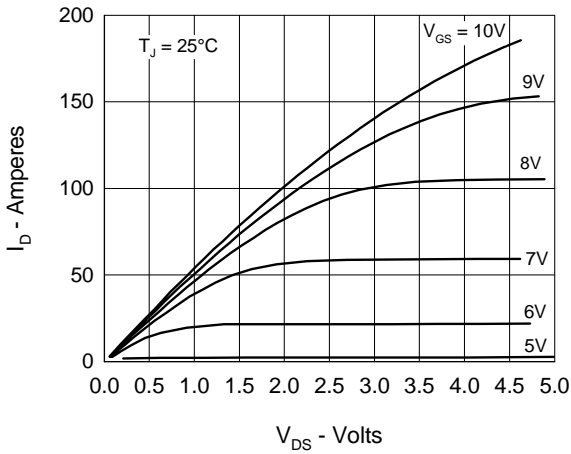


Fig. 2 Input Admittance

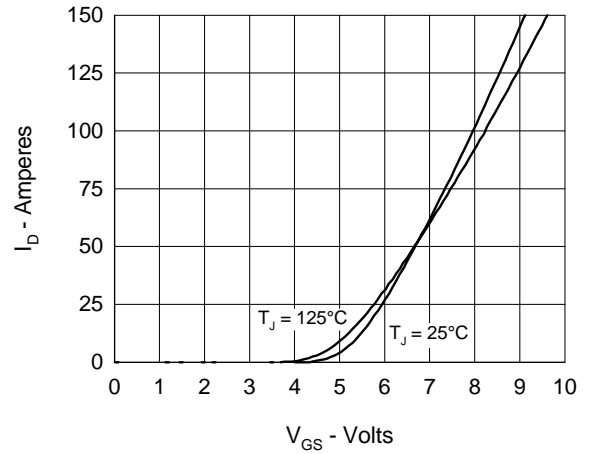


Fig. 3  $R_{DS(on)}$  vs. Drain Current

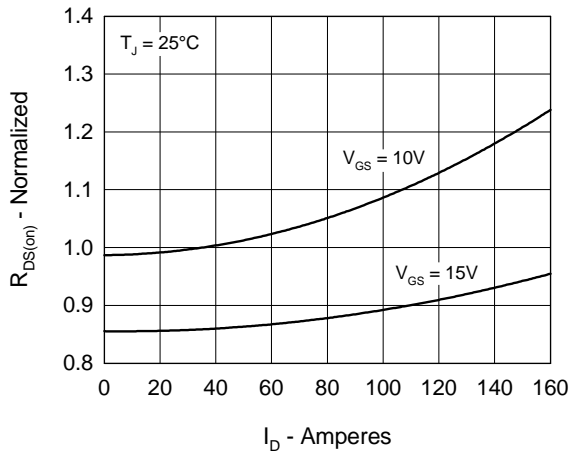


Fig. 4 Temperature Dependence of Drain to Source Resistance

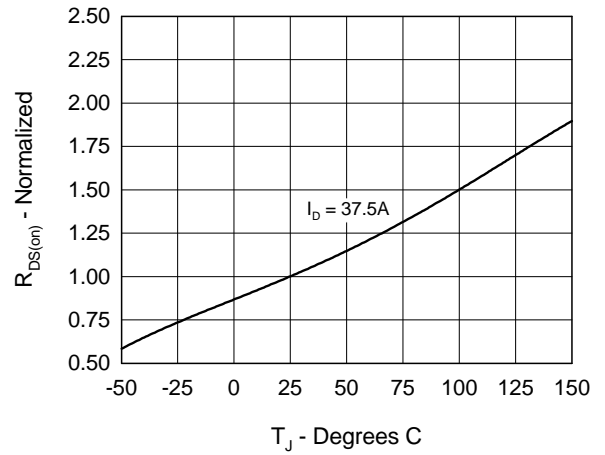


Fig. 5 Drain Current vs. Case Temperature

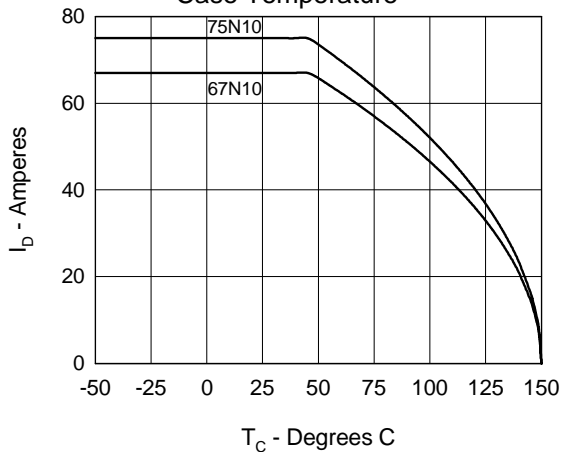
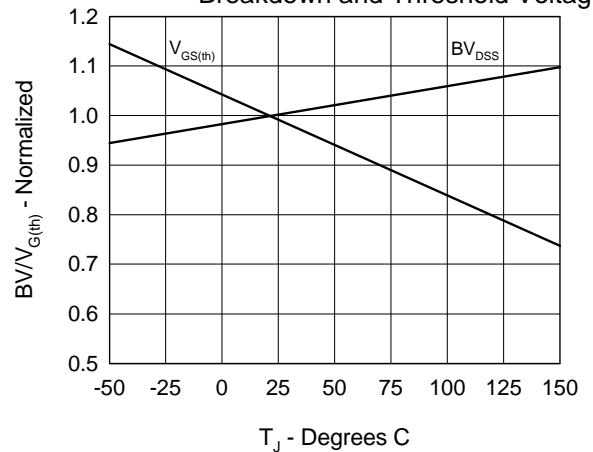
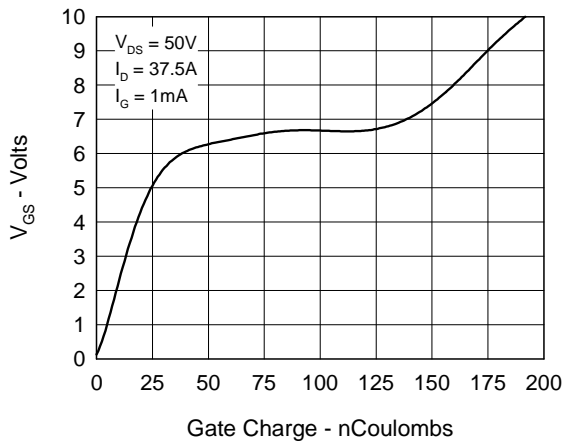
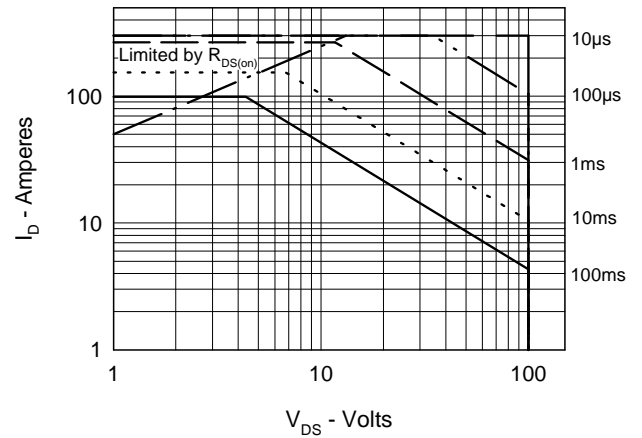
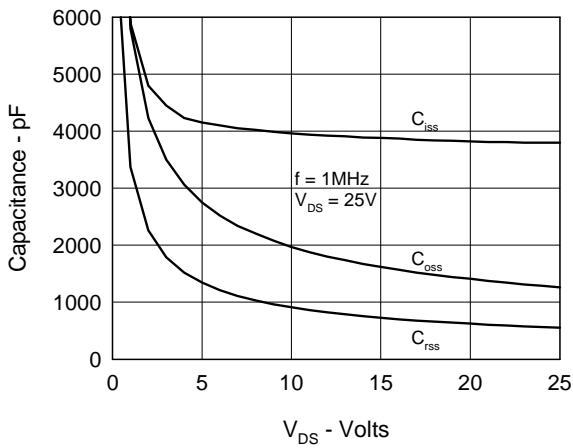
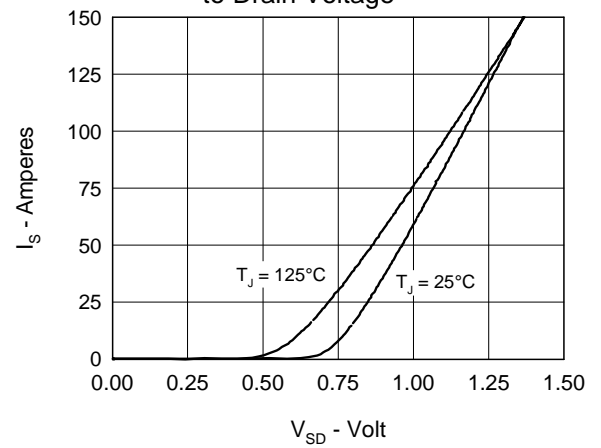
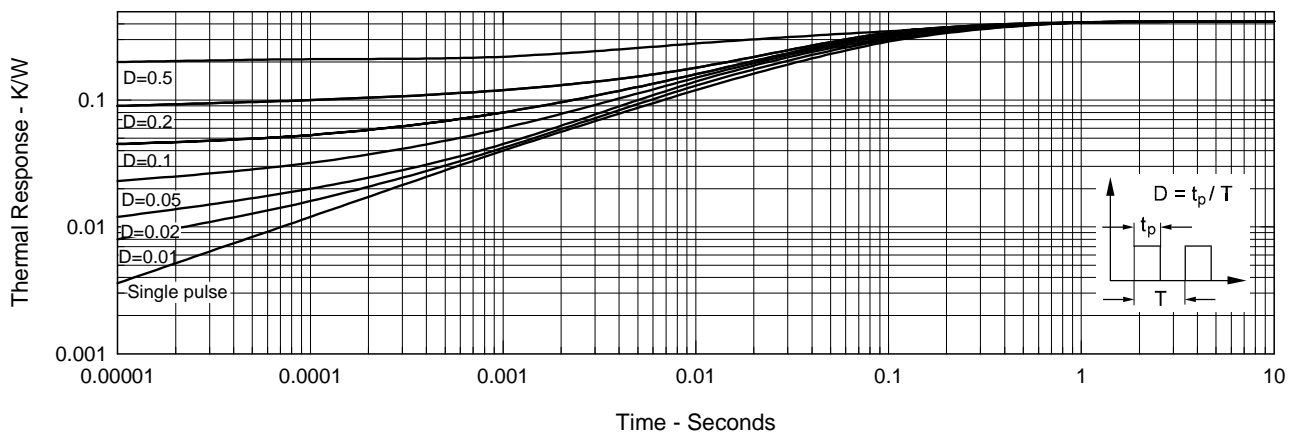


Fig. 6 Temperature Dependence of Breakdown and Threshold Voltage



**Fig.7 Gate Charge Characteristic Curve**

**Fig.8 Forward Bias Safe Operating Area**

**Fig.9 Capacitance Curves**

**Fig.10 Source Current vs. Source to Drain Voltage**

**Fig.11 Transient Thermal Impedance**




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